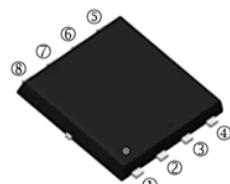


RoHS Compliant Product
A suffix of "-C" specifies halogen free

DESCRIPTION

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

PR-8PP

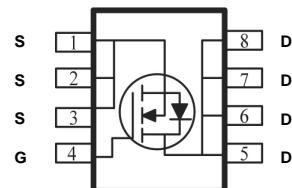


FEATURES

- Fast Switching
- Improved dv/dt Capability
- Green Device Available

PACKAGE INFORMATION

Package	MPQ	Leader Size
PR-8PP	3K	13 inch



ORDER INFORMATION

Part Number	Type
SPR50N04-C	Lead (Pb)-free and Halogen-free

ABSOLUTE MAXIMUM RATINGS ($T_c=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	50	A
		32	
Pulsed Drain Current ¹	I_{DM}	69	A
Power Dissipation	P_D	55.5	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55~150	°C
Thermal Resistance Ratings			
Maximum Thermal Resistance Junction-Ambient	$R_{\theta JA}$	62	°C/W
Maximum Thermal Resistance Junction-Case	$R_{\theta JC}$	2.25	

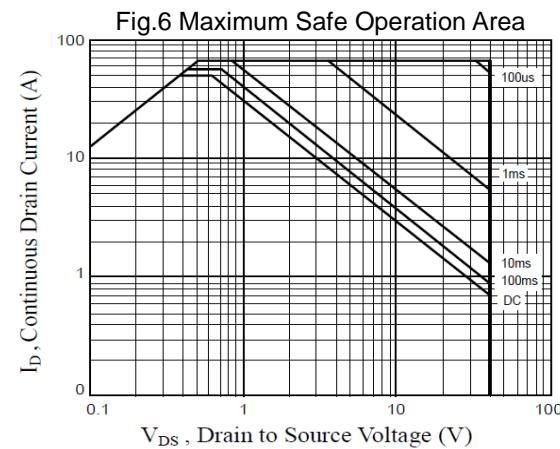
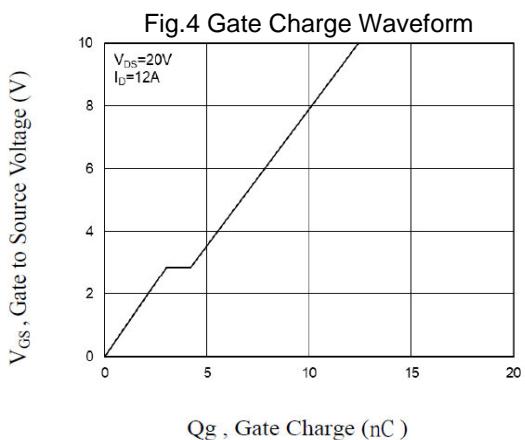
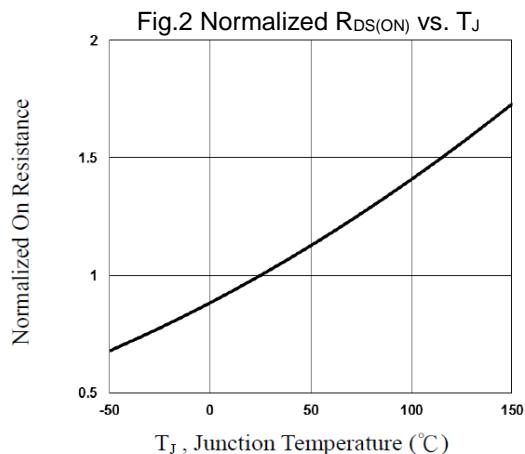
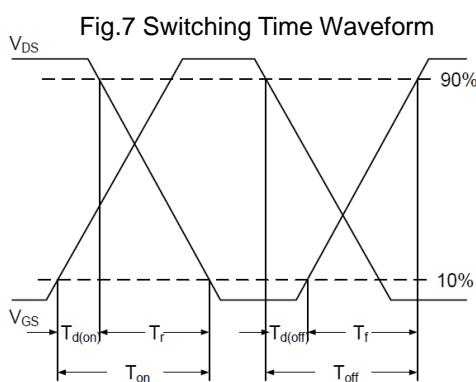
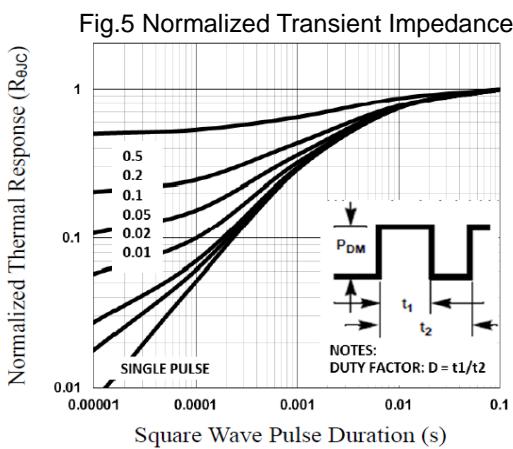
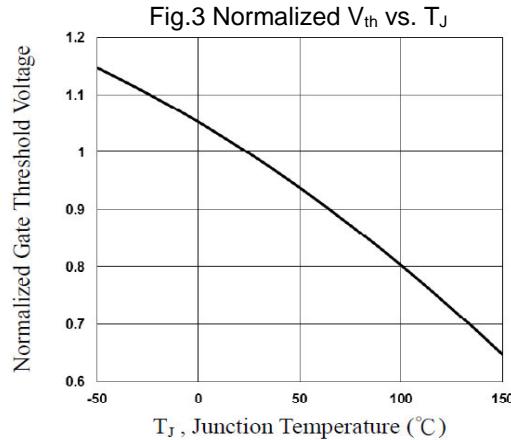
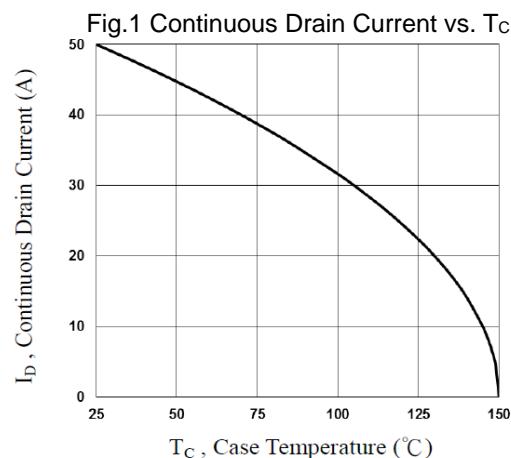
ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Drain-Source Breakdown Voltage	BV_{DSS}	40	-	-	V	$\text{V}_{\text{GS}}=0, \text{I}_D=250\mu\text{A}$
Gate Threshold Voltage	$\text{V}_{\text{GS(th)}}$	1.2	1.6	2.5	V	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$
Gate-Source Leakage Current	I_{GSS}	-	-	± 100	nA	$\text{V}_{\text{GS}}= \pm 20\text{V}, \text{V}_{\text{DS}}=0$
Drain-Source Leakage Current	I_{DSS}	-	-	1	μA	$\text{V}_{\text{DS}}=32\text{V}, \text{V}_{\text{GS}}=0, \text{T}_J=25^\circ\text{C}$
Static Drain-Source On-Resistance ²	$\text{R}_{\text{DS(ON)}}$	-	-	6.5	mΩ	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=10\text{A}$
		-	-	11		$\text{V}_{\text{GS}}=4.5\text{V}, \text{I}_D=5\text{A}$
Gate Resistance	R_g	-	1.7	-	Ω	$\text{V}_{\text{GS}}=\text{V}_{\text{DS}}=0\text{V}, f=1\text{MHz}$
Forward Transconductance	g_{fs}	-	8	-	S	$\text{V}_{\text{DS}}=10\text{V}, \text{I}_D=5\text{A}$
Total Gate Charge	Q_g	-	5.8	-	nC	$\text{V}_{\text{DS}}=20\text{V}$
Gate-Source Charge	Q_{gs}	-	3	-		$\text{V}_{\text{GS}}=4.5\text{V}$
Gate-Drain Change	Q_{gd}	-	1.2	-		$\text{I}_D=12\text{A}$
Turn-on Delay Time	$\text{T}_{\text{d(on)}}$	-	14.3	-	nS	$\text{V}_{\text{DD}}=15\text{V}$
Rise Time	T_r	-	5.6	-		$\text{V}_{\text{GS}}=10\text{V}$
Turn-off Delay Time	$\text{T}_{\text{d(off)}}$	-	20	-		$\text{I}_D=1\text{A}$
Fall Time	T_f	-	11	-		$\text{R}_G=3.3\Omega$
Input Capacitance	C_{iss}	-	690	-	pF	$\text{V}_{\text{DS}}=15\text{V}$
Output Capacitance	C_{oss}	-	193	-		$\text{V}_{\text{GS}}=0$
Reverse Transfer Capacitance	C_{rss}	-	38	-		$f=1\text{MHz}$
Source-Drain Diode						
Continuous Source Current	I_s	-	-	50	A	$\text{V}_G=\text{V}_D=0\text{V}$, Force Current
Diode Forward Voltage	V_{SD}	-	-	1	V	$\text{V}_{\text{GS}}=0, \text{I}_s=1\text{A}, \text{T}_J=25^\circ\text{C}$

Notes:

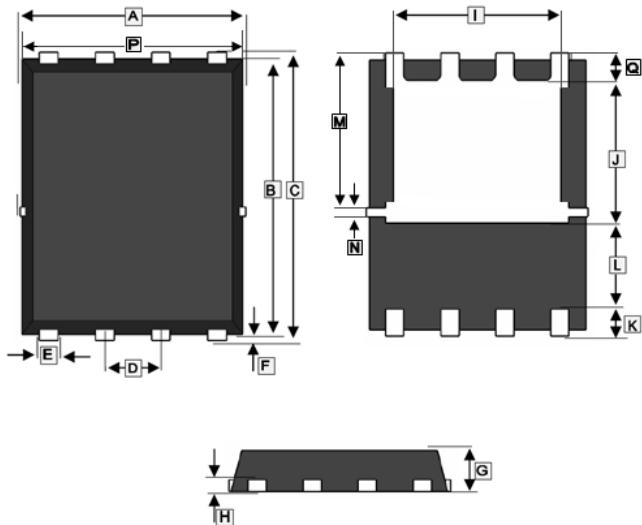
1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed, Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.

CHARACTERISTICS CURVES



PACKAGE OUTLINE DIMENSIONS

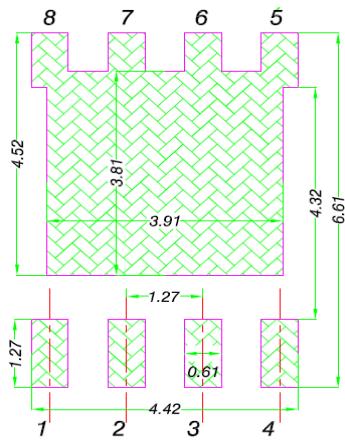
PR-8PP



REF.	Millimeter	
	Min.	Max.
A	4.80	5.40
B	5.45	6.06
C	5.80	6.35
D	1.27 BSC.	
E	0.30	0.51
F	0.05	0.36
G	0.80	1.30
H	0.254 REF.	
I	3.80 REF.	
J	3.60 REF.	
K	0.60 REF.	
L	1.10 REF.	
M	3.75 REF.	
N	0.25 REF.	
P	4.80	5.00
Q	0.50 REF.	

MOUNTING PAD LAYOUT

PR-8PP



*Dimensions in millimeters